

XP131A0232SR



Power MOS FET

◆N-Channel Power MOS FET

◆DMOS Structure

◆Low On-State Resistance: 0.032Ω (max)

◆Ultra High-Speed Switching

◆SOP-8 Package

■Applications

- Notebook PCs
- Cellular and portable phones
- On-board power supplies
- Li-ion battery systems

■General Description

The XP131A0232SR is an N-Channel Power MOS FET with low on-state resistance and ultra high-speed switching characteristics. Because high-speed switching is possible, the IC can be efficiently set thereby saving energy. The small SOP-8 package makes high density mounting possible.

■Features

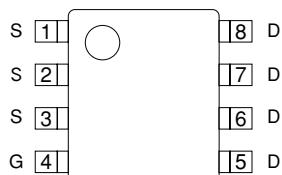
Low on-state resistance : $R_{ds(on)}=0.032\Omega$ ($V_{gs}=4.5V$)
: $R_{ds(on)}=0.045\Omega$ ($V_{gs}=2.5V$)
: $R_{ds(on)}=0.08\Omega$ ($V_{gs}=1.5V$)

Ultra high-speed switching

Operational Voltage : 1.5V

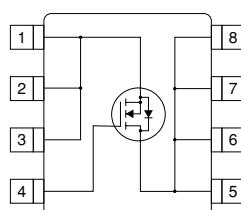
High density mounting : SOP-8

■Pin Configuration



SOP-8
(TOP VIEW)

■Equivalent Circuit



N-Channel MOS FET
(1 device built-in)

■Pin Assignment

PIN NUMBER	PIN NAME	FUNCTION
1 ~ 3	S	Source
4	G	Gate
5 ~ 8	D	Drain

■Absolute Maximum Ratings

Ta=25°C

PARAMETER	SYMBOL	RATINGS	UNITS
Drain-Source Voltage	Vdss	20	V
Gate-Source Voltage	Vgss	±8	V
Drain Current (DC)	Id	8	A
Drain Current (Pulse)	Idp	25	A
Reverse Drain Current	ldr	8	A
Continuous Channel Power Dissipation (note)	Pd	2.5	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	-55~150	°C

Note: When implemented on a glass epoxy PCB

■ Electrical Characteristics

DC Characteristics

Ta=25°C

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Drain Cut-off Current	Idss	Vds=20V, Vgs=0V			10	µA
Gate-Source Leakage Current	Igss	Vgs=±8V, Vds=0V			±10	µA
Gate-Source Cut-off Voltage	Vgs(off)	Id=1mA, Vds=10V	0.5			V
Drain-Source On-state Resistance (note)	Rds(on)	Id=4A, Vgs=4.5V		0.025	0.032	Ω
		Id=4A, Vgs=2.5V		0.035	0.045	Ω
		Id=4A, Vgs=1.5V		0.055	0.08	Ω
Forward Transfer Admittance (note)	Yfs	Id=4A, Vds=10V		18		S
Body Drain Diode Forward Voltage	Vf	If=8A, Vgs=0V		0.85	1.1	V

Note: Effective during pulse test.

Dynamic Characteristics

Ta=25°C

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Input Capacitance	Ciss	Vds=10V, Vgs=0V f=1MHz		1200		pF
Output Capacitance	Coss			550		pF
Feedback Capacitance	Crss			180		pF

Switching Characteristics

Ta=25°C

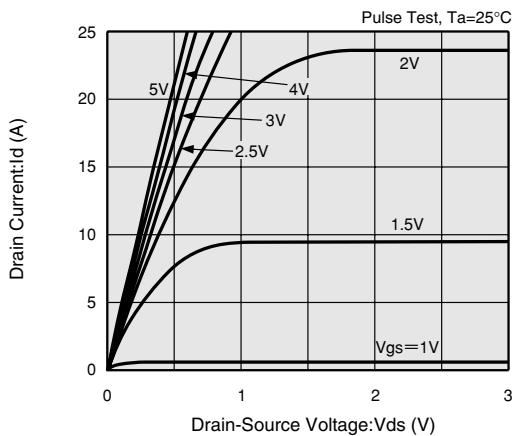
PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Turn-on Delay Time	td (on)	Vgs=5V, Id=4A Vdd=10V		15		ns
Rise Time	tr			15		ns
Turn-off Delay Time	td (off)			80		ns
Fall Time	tf			10		ns

Thermal Characteristics

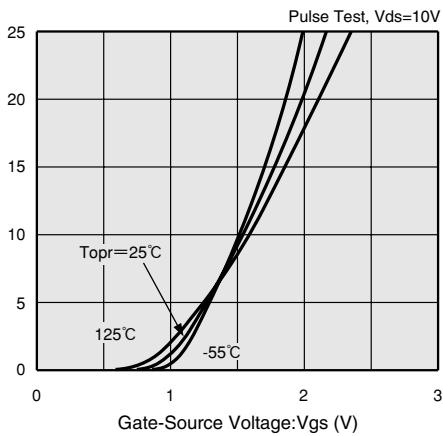
PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Thermal Resistance (channel-ambience)	Rth (ch-a)	Implement on a glass epoxy resin PCB		50		°C/W

■ Typical Performance Characteristics

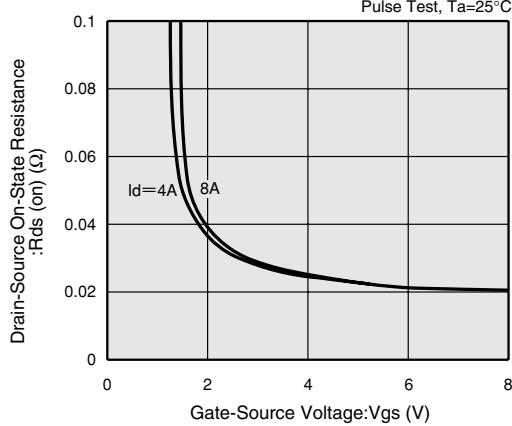
DRAIN CURRENT vs. DRAIN-SOURCE VOLTAGE



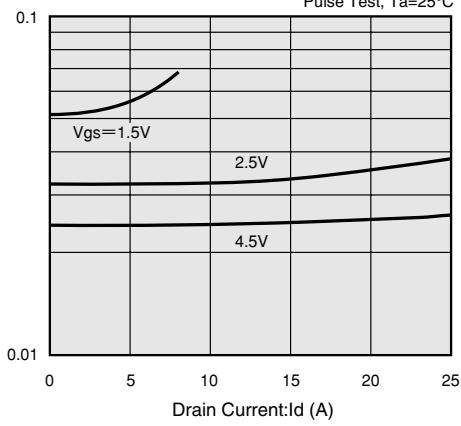
DRAIN CURRENT vs. GATE-SOURCE VOLTAGE



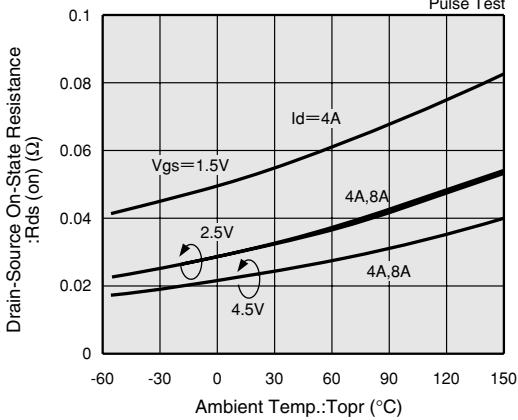
DRAIN-SOURCE ON-STATE RESISTANCE vs. GATE-SOURCE VOLTAGE



DRAIN-SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT



DRAIN-SOURCE ON-STATE RESISTANCE vs. AMBIENT TEMPERATURE



GATE-SOURCE CUT-OFF VOLTAGE VARIANCE vs. AMBIENT TEMPERATURE

